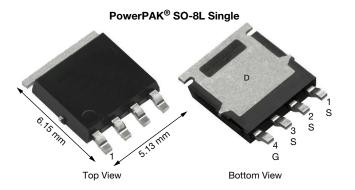
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Automotive P-Channel 30 V (D-S) 175 °C MOSFET



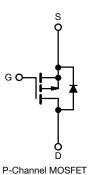
PRODUCT SUMMARY	
V _{DS} (V)	-30
$R_{DS(on)} (\Omega)$ at $V_{GS} = -10 V$	0.0092
$R_{DS(on)} (\Omega)$ at $V_{GS} = -4.5 \text{ V}$	0.0146
I _D (A)	-30
Configuration	Single
Package	PowerPAK SO-8L

FEATURES

- TrenchFET[®] power MOSFET
- AEC-Q101 qualified
- 100 % R_q and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



RoHS COMPLIANT HALOGEN FREE



ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)							
PARAMETER		SYMBOL	LIMIT	UNIT			
Drain-source voltage		V _{DS}	-30	V			
Gate-source voltage		V _{GS}	± 20	v			
Continuous drain current ^a	T _C = 25 °C	I _D	-30				
Continuous drain current	T _C = 125 °C	U	-30				
Continuous source current (diode conduction) ^a		ls	-30	А			
Pulsed drain current ^b		I _{DM}	-120				
Single pulse avalanche current	- L = 0.1 mH	I _{AS}	-26				
Single pulse avalanche energy		E _{AS}	33.8	mJ			
Maximum power dissipation ^b	T _C = 25 °C	P _D	45	W			
	T _C = 125 °C		15	vv			
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +175	°C			
Soldering recommendations (peak temperature) ^{d, e}			260	U			

THERMAL RESISTANCE RATINGS				
PARAMETER		SYMBOL	LIMIT	UNIT
Junction-to-ambient	PCB mount ^c	R _{thJA}	70	°C/W
Junction-to-case (drain)		R _{thJC}	3.3	0/10

Notes

- b. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 $\,\%$
- c. When mounted on 1" square PCB (FR4 material)

d. See solder profile (www.vishay.com/doc?73257). For PowerPAK SO-8L, the end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection

e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components

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a. Package limited

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PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
Static					•			
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0, I_D = -250 \ \mu A$		-30	-	-	v	
Gate-source threshold voltage	V _{GS(th)}	V _{DS} =	V _{DS} = V _{GS} , I _D = -250 μA		-2.0	-2.5	v	
Gate-source leakage	I _{GSS}	V _{DS} =	0 V, $V_{GS} = \pm 20 V$	-	-	± 100	nA	
		$V_{GS} = 0 V$	V _{DS} = -30 V	-	-	-1		
Zero gate voltage drain current	I _{DSS}	V _{GS} = 0 V	V _{DS} = -30 V, T _J = 125 °C	-	-	-50	μA	
		V _{GS} = 0 V	V _{DS} = -30 V, T _J = 175 °C	-	-	-200		
On-state drain current ^a	I _{D(on)}	V _{GS} = -10 V	$V_{DS} \ge -5 V$	-20	-	-	А	
		V _{GS} = -10 V	I _D = -6 A	-	0.0076	0.0092		
		V _{GS} = -10 V	I _D = -6 A, T _J = 125 °C	-	-	0.0112	Ω	
Drain-source on-state resistance ^a	R _{DS(on)}	V _{GS} = -10 V	I _D = -6 A, T _J = 175 °C	-	-	0.0122		
		V _{GS} = -4.5 V	I _D = -5 A	-	0.0120	0.0146	-	
Forward transconductance b	9 _{fs}		= -15 V, I _D = -6 A	-	32	-	S	
Dynamic ^b	0.0		. 5	L		L	I	
Input capacitance	C _{iss}			-	3620	4900		
Output capacitance	C _{oss}	V _{GS} = 0 V	V _{DS} = -25 V, f = 1 MHz	-	360	500	рF	
Reverse transfer capacitance	C _{rss}			-	346	470		
Total gate charge ^c	Qg			-	65	100		
Gate-source charge ^c	Q _{gs}	V _{GS} = -10 V	V _{DS} = -15 V, I _D = -5 A	-	9	-	nC	
Gate-drain charge ^c	Q _{gd}			-	12	-		
Gate resistance	R _q		f = 1 MHz		4.8	7.2	Ω	
Turn-on delay time ^c	t _{d(on)}			-	12	20		
Rise time ^c	tr	- Voo	= -15 V, R _I = 3 Ω	-	4	10	1	
Turn-off delay time ^c	t _{d(off)}	$I_D \cong -5 \text{ A}, V_{GEN} = -10 \text{ V}, \text{ R}_g = 1 \Omega$		-	64	100	ns	
Fall time ^c	tf			-	24	40		
Source-Drain Diode Ratings and Chara	cteristics b						I	
Pulsed current ^a	I _{SM}			-	-	-120	А	
Forward voltage	V _{SD}	I _F = -6 A, V _{GS} = 0 V		-	-0.78	-1.2	V	
Body diode reverse recovery time	t _{rr}	I _F = -4 A, di/dt = 100 A/μs		-	22	45	ns	
Body diode reverse recovery charge	Q _{rr}			-	11	25	nC	
Reverse recovery fall time	ta			-	11	-	ns	
Reverse recovery rise time	t _b			-	11	-	115	
Body diode peak reverse recovery current	I _{RM(REC)}			-	-0.9	-	Α	

Notes

a. Pulse test; pulse width \leq 300 $\mu s,\,duty\,cycle \leq 2\,$ %

b. Guaranteed by design, not subject to production testing

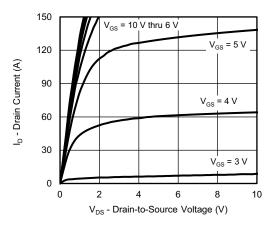
c. Independent of operating temperature

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

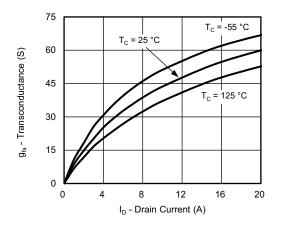
2



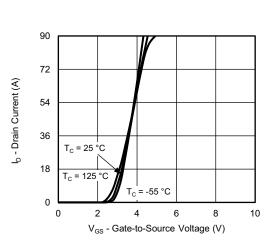
TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)



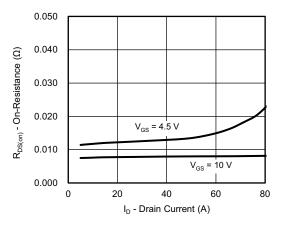
Output Characteristics



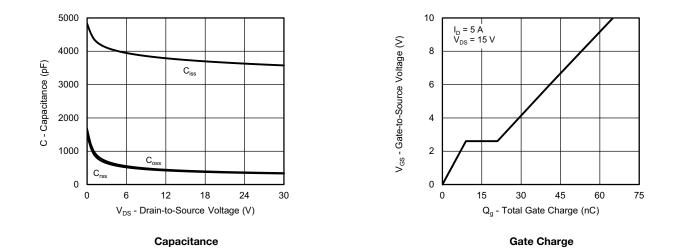
Transconductance



Transfer Characteristics



On-Resistance vs. Drain Current



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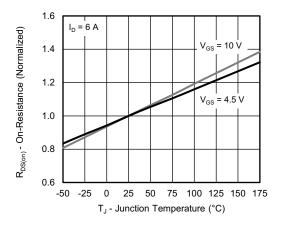
3

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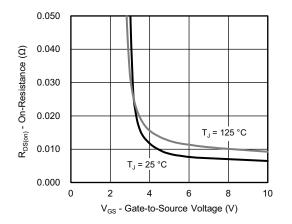
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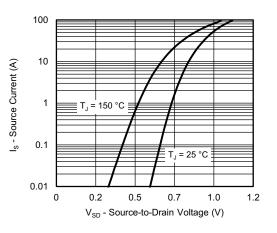
TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)



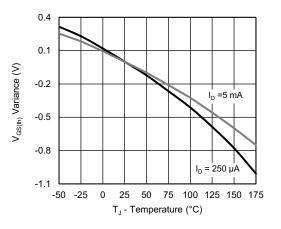
On-Resistance vs. Junction Temperature



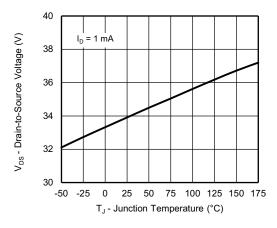
On-Resistance vs. Gate-to-Source Voltage



Source Drain Diode Forward Voltage



Threshold Voltage



Drain-Source Breakdown vs. Junction Temperature

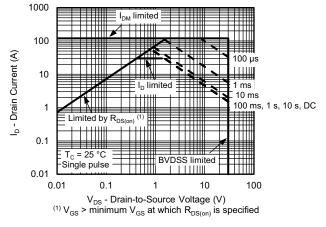
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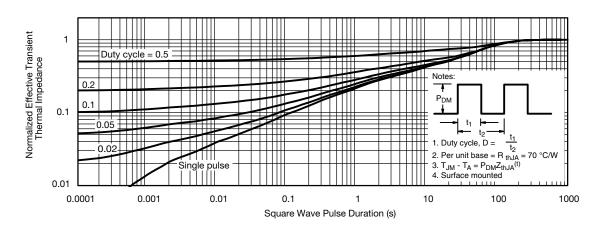
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THERMAL RATINGS (T_C = 25 °C, unless otherwise noted)



Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Ambient

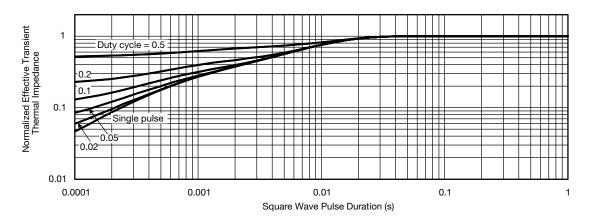


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THERMAL RATINGS (T_C = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

Note

The characteristics shown in the two graphs

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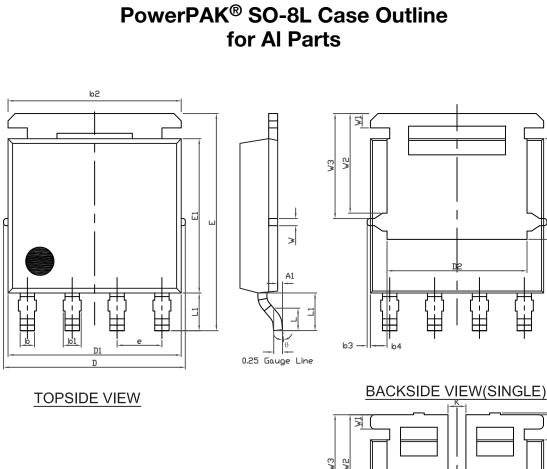
- Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
- Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?75171.

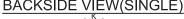


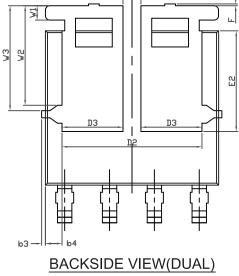
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Revision: 07-Sep-15





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Package Information



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DIM		MILLIMETERS		INCHES			
DIM.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
А	1.00	1.07	1.14	0.039	0.042	0.045	
A1	0.00	-	0.127	0.00	-	0.005	
b	0.33	0.41	0.48	0.013	0.016	0.019	
b1	0.44	0.51	0.58	0.017	0.020	0.023	
b2	4.80	4.90	5.00	0.189	0.193	0.197	
b3		0.094	•		0.004		
b4		0.47			0.019		
С	0.20	0.25	0.30	0.008	0.010	0.012	
D	5.00	5.13	5.25	0.197	0.202	0.207	
D1	4.80	4.90	5.00	0.189	0.193	0.197	
D2	3.86	3.96	4.06	0.152	0.156	0.160	
D3	1.63	1.73	1.83	0.064	0.068	0.072	
е		1.27 BSC	•	0.050 BSC			
E	6.05	6.15	6.25	0.238	0.242	0.246	
E1	4.27	4.37	4.47	0.168	0.172	0.176	
E2	2.75	2.85	2.95	0.108	0.112	0.116	
F	-	-	0.15	-	-	0.006	
L	0.62	0.72	0.82	0.024	0.028	0.032	
L1	0.92	1.07	1.22	0.036	0.042	0.048	
К		0.51			0.020		
W	0.23			0.009			
W1	0.41			0.016			
W2	2.82			0.111			
W3		2.96		0.117			
q	0°	-	10°	0°	-	10°	

Note

• Millimeters will gover



RECOMMENDED MINIMUM PAD FOR PowerPAK[®] SO-8L SINGLE



Recommended Minimum Pads Dimensions in mm (inches)

Revision: 07-Feb-12



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